4 and 8-Channel ESD Protection Arrays in CSP

Description

The CM1220 ESD protection arrays are available in four and eight channel configurations. Each ESD channel features a nominal capacitance of 14 pF making the devices ideal for protecting high speed I/O ports and LCD and camera data lines without significantly affecting signal integrity. The CM1220 integrates avalanche-type ESD diodes on every channel, providing a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). These diodes safely dissipate ESD strikes of ± 15 kV, exceeding the maximum requirement of the IEC61000-4-2 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the CM1220 protect against contact discharges at greater than ± 30 kV.

These devices are particularly well-suited for portable electronics (e.g. wireless handsets, PDAs, notebook computers) because of their small package and easy-to-use pin assignments. In particular, the CM1220 is ideal for protecting high speed I/O ports and data and control lines for the LCD display and camera interface in mobile handsets.

The CM1220 incorporates ON Semiconductor's *OptiGuard*[™] coating for improved reliability at assembly in a space–saving, low–profile Chip Scale Package.

Features

- Four and Eight Channels of ESD Protection
- OptiGuard[™] Coated for Improved Reliability
- ±15 kV ESD Protection on each Channel (IEC 61000-4-2 Level 4, contact discharge)
- ±30 kV ESD Protection on each Channel (HBM)
- Chip Scale Package (CSP) Features Extremely Low Lead Inductance for Optimum ESD Protection
- 5 bump, 0.960 mm X 1.330 mm CSP Footprint for CM1220-04
- 10 bump, 1.960 mm X 1.330 mm CSP Footprint for CM1220-08
- These Devices are Pb-Free and are RoHS Compliant

Applications

- LCD and Camera Data Lines in Mobile Handsets
- I/O Port Protection for Mobile Handsets, Notebook Computers, PDAs, etc.
- Keypads and Buttons
- Wireless Handsets
- Handheld PCs/PDAs
- LCD and Camera Modules



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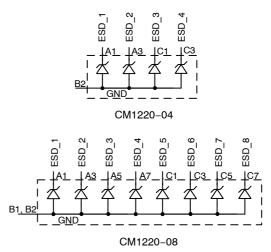




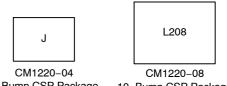
WLCSP5 CP SUFFIX CASE 567AY

WLCSP10 CP SUFFIX CASE 567BL

BLOCK DIAGRAM



MARKING DIAGRAM



5-Bump CSP Package

10-Bump CSP Package

ORDERING INFORMATION

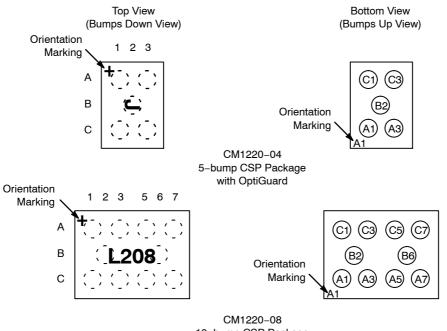
Device	Package	Shipping [†]
CM1220-04CP	CSP-5 (Pb-Free)	3500/Tape & Reel
CM1220-08CP	CSP-10 (Pb-Free)	3500/Tape & Reel

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

J = CM1220-04CP L208 = CM1220-08CP

CM1220

PACKAGE / PINOUT DIAGRAMS



10-bump CSP Package with OptiGuard

Table 1. PIN DESCRIPTIONS

CM1220-08		CM1220-04			CM1220-08		CM12	20-04	
Pins	Name	Pins	Name	Description	Pins	Name	Pins	Name	Description
A1	ESD1	A1	ESD1	ESD Channel	C1	ESD5	C1	ESD3	ESD Channel
A3	ESD2	A3	ESD2	ESD Channel	C3	ESD6	C3	ESD4	ESD Channel
A5	ESD3	-	-	ESD Channel	C5	ESD7	-	-	ESD Channel
A7	ESD4	-	-	ESD Channel	C7	ESD8	-	-	ESD Channel
B2	GND	B2	GND	Device Ground	B6	GND	-	-	Device Ground

SPECIFICATIONS

Table 2. ABSOLUTE MAXIMUM RATINGS

Parameter	Rating	Units
Storage Temperature Range	-65 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 3. STANDARD OPERATING CONDITIONS

Parameter	Rating	Units
Operating Temperature Range	-40 to +85	°C

CM1220

Symbol	Parameter	Conditions	Min	Тур	Max	Units
C _{DIODE}	Diode (Channel) Capacitance	At 2.5 VDC Reverse Bias, 1 MHz, 30 mVAC	11	14	17	pF
V _{DIODE}	Diode Standoff Voltage	I _{DIODE} = 10 μA		6.0		V
I _{LEAK}	Diode Leakage Current	V _{IN} = +3.3 V (reverse bias voltage)		0.1	1	μA
V _{SIG}	Signal Clamp Voltage Positive Clamp Negative Clamp	I _{DIODE} = 10 mA	5.6 -1.5	6.8 -0.8	9.0 -0.4	V
V _{ESD}	In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-2	(Note 2)	±30 ±15			kV
R _{DYN}	Dynamic Resistance Positive Negative			2.3 0.9		Ω

Table 4. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

T_A = 25 °C unless otherwise specified.
ESD applied to input and output pins with respect to GND, one at a time. Unused pins are left open.

PERFORMANCE INFORMATION

Diode Characteristics (nominal conditions unless specified otherwise)

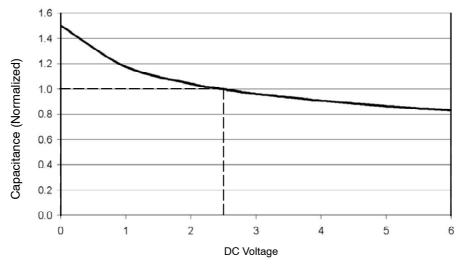


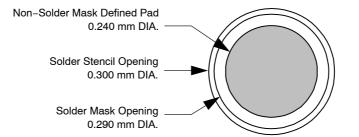
Figure 1. Insertion Loss vs. Frequency (0 V Bias)

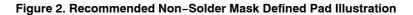
CM1220

APPLICATION INFORMATION

Table 5. PRINTED CIRCUIT BOARD RECOMMENDATIONS

Parameter	Value	
Pad Size on PCB	0.240 mm	
Pad Shape	Round	
Pad Definition	Non-Solder Mask defined pads	
Solder Mask Opening	0.290 mm Round	
Solder Stencil Thickness	0.125 – 0.150 mm	
Solder Stencil Aperture Opening (laser cut, 5% tapered walls)	0.300 mm Round	
Solder Flux Ratio	50/50 by volume	
Solder Paste Type	No Clean	
Pad Protective Finish	OSP (Entek Cu Plus 106A)	
Tolerance – Edge To Corner Ball	±50 μm	
Solder Ball Side Coplanarity	±20 μm	
Maximum Dwell Time Above Liquidous (183°C)	60 seconds	
Maximum Soldering Temperature for Lead-free Devices using a Lead-free Solder Paste	260°C	





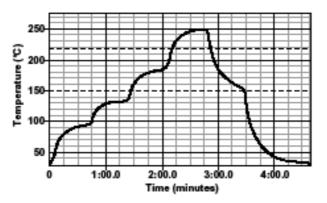
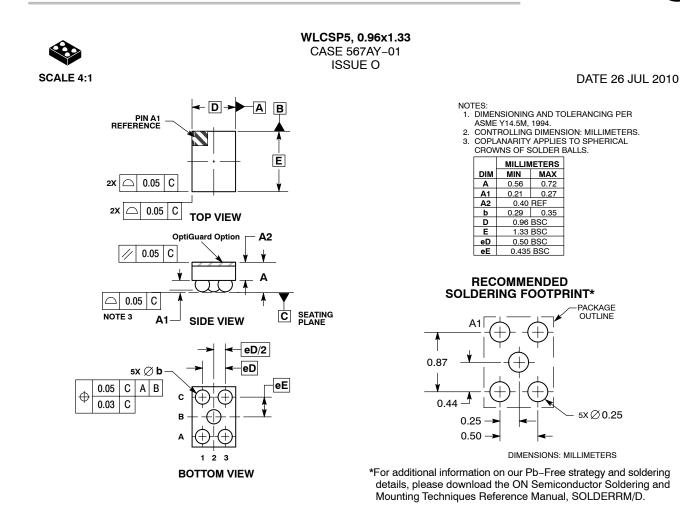


Figure 3. Lead-free (SnAgCu) Solder Ball Reflow Profile

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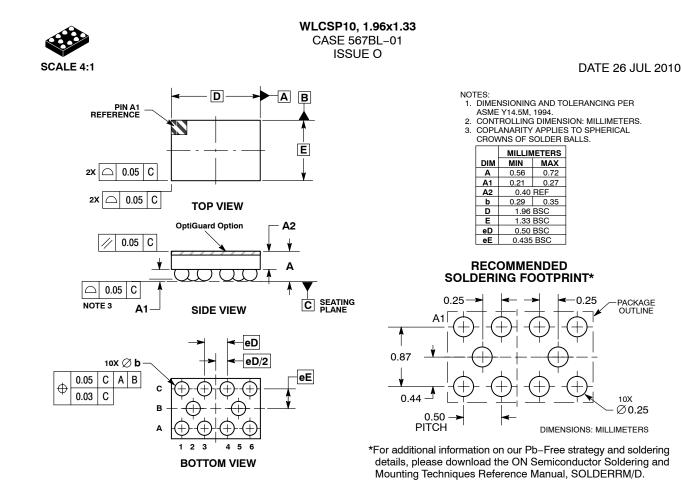


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